SHEET

U.S. Department of Commerce Patent and Trademark Offi

To the Honorable Comm	issioner of Pa	ate 1010178	89 original documents or copy thereof
Name of conve	eying party		2. Name and address of receiving party(ies):
Sukesh Sandhu and Gurtej S. Sandhu			Name: Micron Technology, Inc.
Additional name(sparty(ies) attache		ying Yes	Internal Address: Street Address: 8000 S. Federal Way
3. Nature of Conv	eyance:		
x Assignment Merger			City: Boise
Security Agreement Change of Name			State: IDAHO Zip: 83707-0006
Other	1	~	Country:
Execution Date(s): April 1, 1999, respectively			Additional name(s) & x Yes address(es) attached?
4. Application nu	mber(s) or	patent number(s):	
		ed together with a new applic new application is (are):	cation, 4/1/99, respectively
A. Patent Application No.(s):			B. Patent No.(s): 09/245667
			Additional numbers attached? Yes X No
5. Name and address of party to whom correspondence concerning document should be mailed:			6. Total number of applications and patents involved:
Name: DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP			7. Total fee (37 C.F.R 3.41) \$ \$40.00
Internal Address: Atty. Dkt.: M4065.0123/P123		M4065.0123/P123	x Enclosed
Attn: Thomas J. D'Amico		J. D'Amico	Authorized to be charged to deposit account
Street Address:	2101 L S	treet NW	Credit any overpayment or debit any underpayment
City: Washington	State: DC	Zip: 20037-1526	8. Deposit account number: 04-1073
		DO NOT USE	THIS SPACE
9. Statement and	d signature).	260 z
		edge and belief, the forege original document.	Oing information is true and correct and any extached April 5, 1999 Date
Thomas J. D'	Amico	<u>_</u>	April 5, 1999
Reg. No. 28,3	371	Signature	Date NHW
Total number	of pages ir	cluding cover sheet, atta	chments, and document: 4
			70 03

REEL: 9889 FRAME: 0087

Docket No.: M4065.123/P123 Micron No.: 98-0611/US

ASSIGNMENT AND AGREEMENT

For value received, we, Gurtej S. Sandhu of Boise, Idaho and Sukesh Sandhu of Boise, Idaho, hereby sell, assign and transfer to Micron Technology Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled HIGH COUPLING SPLIT-GATE TRANSISTOR AND METHOD FOR ITS FORMATION described in an application for Letters Patent of the United States, executed by us of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United State for said inventions; and we also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

We agree that, when requested, we shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

1

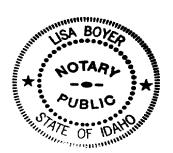
1

Docket No.: M4065.123/P123 Micron No.: 98-0611/US

Gurtej S. Sandhu

Date

On this ____ day of ______, 1999, before me personally came Gurtej S. Sandhu, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.



Notary Public

Docket No.: M4065.123/P123 Micron No.: 98-0611/US

Sukesh Sandhu Sukesh Sandhu Date: 4/1/99
United States of America) State of <u>Cdaho</u>)ss.: County of <u>Qda</u>)
On this day of, 1999, before me personally came Sukesh Sandhu, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.
Notary Public

RECORDED: 04/05/1999